

FIG. 1

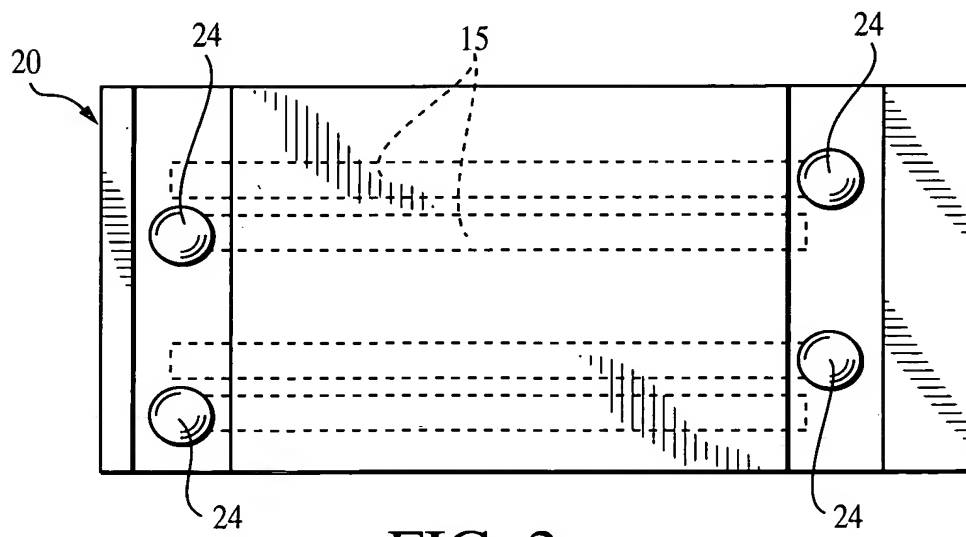


FIG. 2

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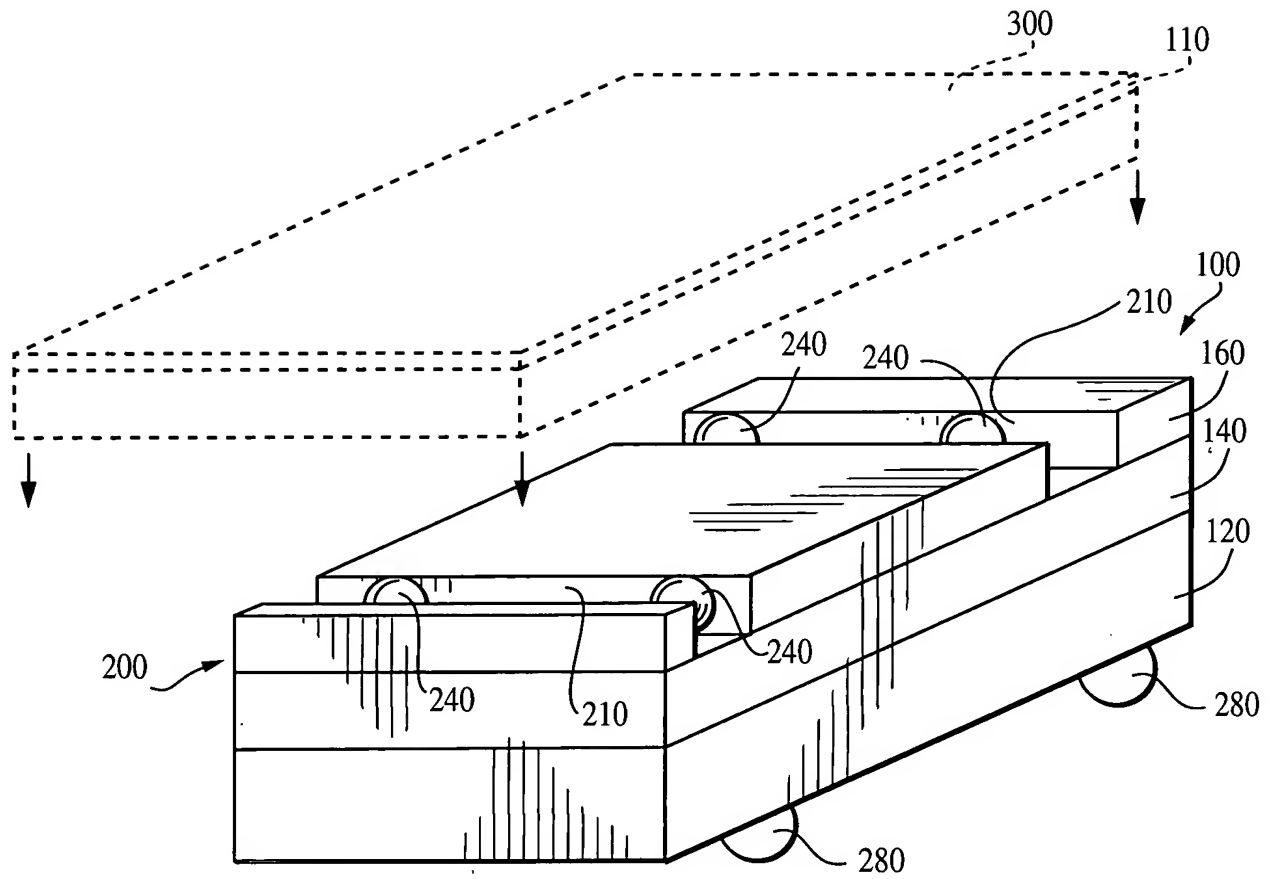


FIG. 3.

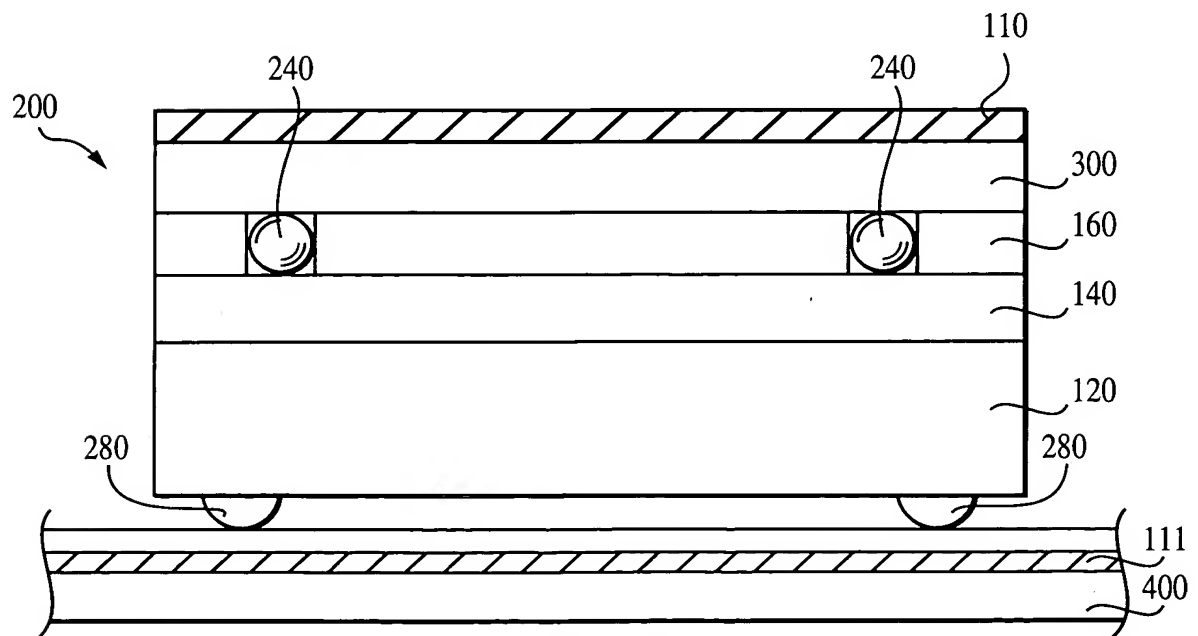


FIG. 4

FIG. 5 is a cross-sectional view of a device 101. The device 101 includes a top layer 110 with diagonal hatching, a layer 300, a layer 160 containing two circular components 240, a layer 140, and a large bottom layer 120. The bottom layer 120 is supported by two curved feet 280. Below the device 101 is a substrate 400 with a top layer 111 and a bottom layer 112, both with diagonal hatching.

FIG. 6 is a cross-sectional view of a device assembly. The assembly includes a top layer 110, a middle layer 300, and a bottom layer 112. The middle layer 300 contains two circular components 240. The bottom layer 112 is supported by a base 400. The entire assembly is labeled 102.